



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Ko et al.

**Serial No.:** 09/711,324

**Filed:** November 13, 2000

**For:** ETCHANT WITH SELECTIVITY FOR  
DOPED SILICON DIOXIDE OVER  
UNDOPED SILICON DIOXIDE AND  
SILICON NITRIDE, PROCESSES WHICH  
EMPLOY THE ETCHANT, AND  
STRUCTURES FORMED THEREBY

**Examiner:** K. Chen

**Group Art Unit:** 1765

**Attorney Docket No.:** 3526.4US  
(97-1136.4)

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231

September 4, 2001  
Date of Deposit

Signature of registered practitioner or other person having reasonable basis to expect mailing to occur on date of deposit shown pursuant to 37 C.F.R. § 1.8(a)(1)(ii)

Deidra Pfeil

Typed printed name of person whose signature is contained above

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
Washington, D.C. 20231

Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the documents listed on attached Form PTO-1449 be considered by the Examiner and made of record. Copies of the listed documents are enclosed pursuant to 37 C.F.R.

§ 1.98(a). The listed documents were cited by the Office in co-pending application Serial No. 09/585,682, filed on June 1, 2000, and directed to a related invention.

In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicants herein that no other possible material information as defined in 37 C.F.R. § 1.56 (b) exists.

DOCUMENTS

U.S. Patent Documents

<u>U.S. Patent No.</u>	<u>Issue Date</u>	<u>Inventor</u>
3,886,569	05/1975	Basi et al.
5,275,972	01/1994	Ogawa et al.

Foreign Patent Documents

<u>Document No.</u>	<u>Date</u>	<u>Country</u>
10-22385	01/1998	JP

Applicants offer to supply any explanation or discussion of the documents which the Examiner feels is necessary or desirable and which is requested.

This Supplemental Information Disclosure Statement is filed after the mailing date of the final Office Action under 37 C.F.R. § 1.113, but before payment of the issue fee. I hereby certify that no item of information contained in the Supplemental Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned after making reasonable inquiry, was known to any individual designated in 37 C.F.R. § 1.56(c) more than three months prior to the filing of the statement. Pursuant to 37 C.F.R. § 1.97(d)(ii), applicant hereby petitions for the consideration of the

accompanying Supplemental Information Disclosure Statement. The fee for consideration of this Supplemental Information Disclosure Statement is enclosed.

Respectfully submitted,



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Date: August 16, 2001

BGP/ps:djp

Enclosures: Form PTO-1449  
Copy of documents cited  
\$180.00 Fee

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